

## LOW CAPACITANCE TVS ARRAY

### APPLICATIONS

- ✓ Ethernet - 10/100 Base T
- ✓ RS-485
- ✓ xDSL & ATM
- ✓ SCSI & USB
- ✓ Audio/Video I/O Ports

### IEC COMPATIBILITY (EN61000-4)

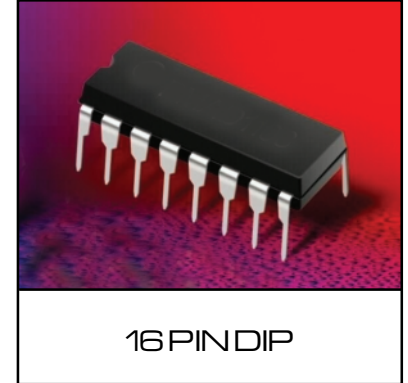
- ✓ 61000-4-2 (ESD): Air - 15kV, Contact - 8kV
- ✓ 61000-4-4 (EFT): 40A - 5/50ns
- ✓ 61000-4-5 (Surge): 24A, 8/20 $\mu$ s Level 2 (Line-Ground) & Level 3 (Line-Line)

### FEATURES

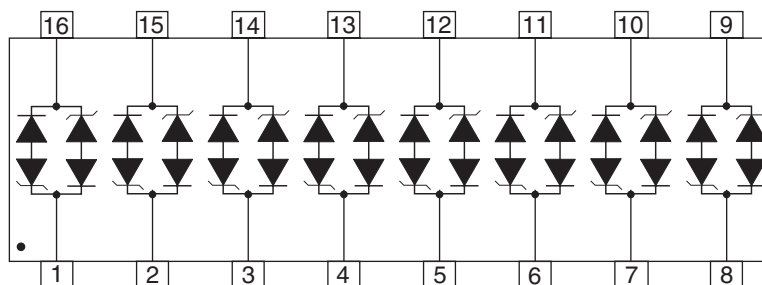
- ✓ 800 Watts Peak Pulse Power per Line ( $t_p=8/20\mu$ s)
- ✓ Bidirectional Configuration
- ✓ ESD Protection > 40 kilovolts
- ✓ Available in Five (5) Voltage Types: 5V to 24V
- ✓ Standard Dual-In-Line Package
- ✓ Protects Up to Eight (8) Lines
- ✓ **LOW CAPACITANCE: 15pF**

### MECHANICAL CHARACTERISTICS

- ✓ Molded 16 Pin Dual-In-Line (DIP) Package
- ✓ Weight 1.2 grams (Approximate)
- ✓ Flammability rating UL 94V-0
- ✓ Packaging: 25 Pieces Per Tube
- ✓ Marking: Logo, Part Number, Date Code & Pin One Defined By Dot on Top of Package



### PIN CONFIGURATION

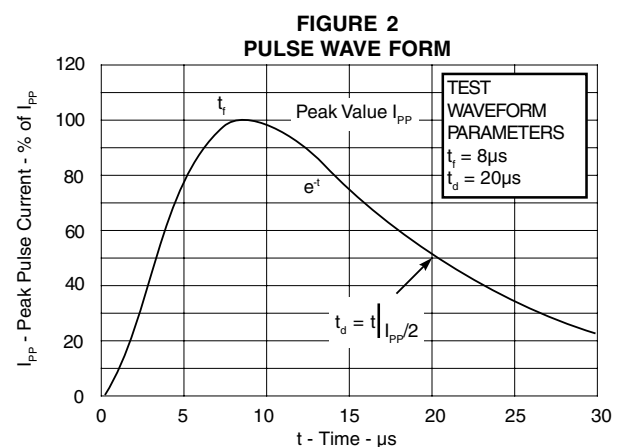
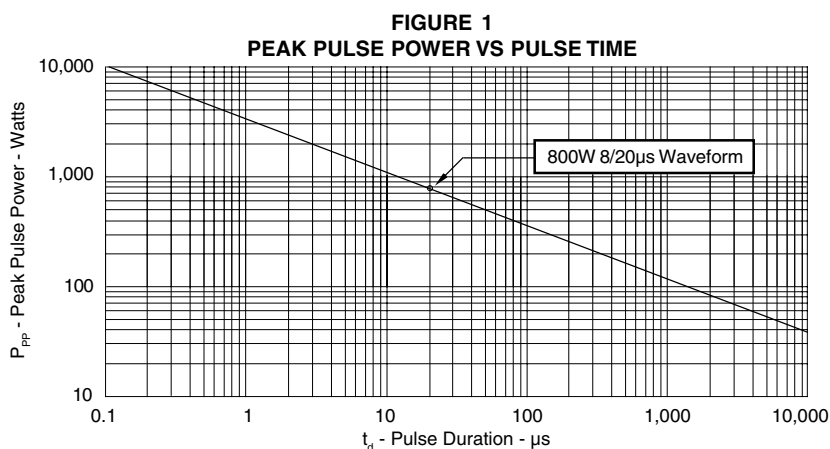


## DEVICE CHARACTERISTICS

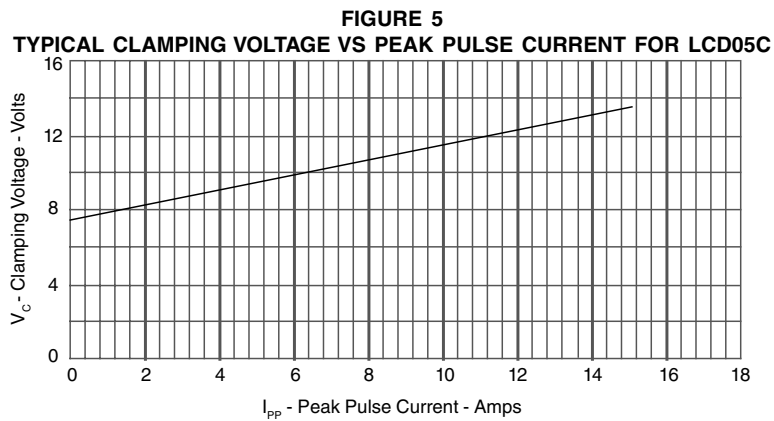
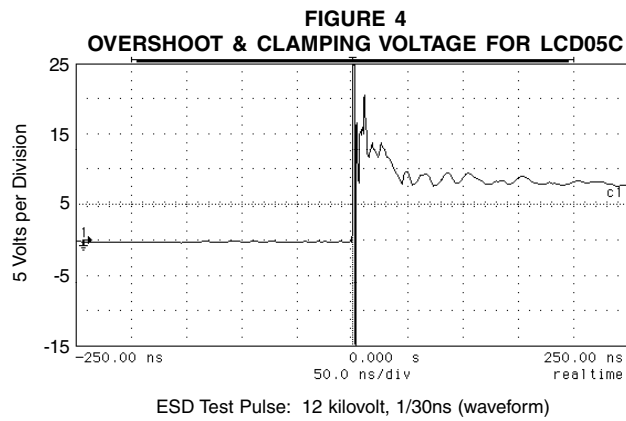
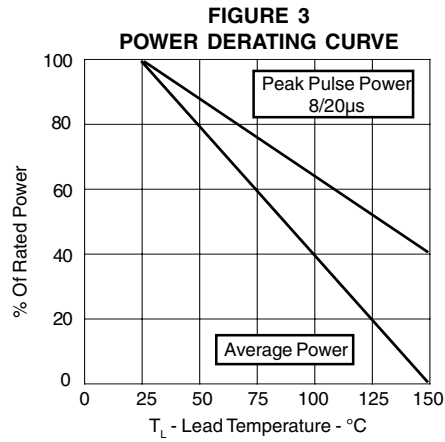
| MAXIMUM RATINGS @ 25°C Unless Otherwise Specified     |           |                |       |
|---|-----------|----------------|-------|
| PARAMETER   | SYMBOL    | VALUE          | UNITS |
| Peak Pulse Power ( $t_p = 8/20\mu s$ ) - See Figure 1 | $P_{PP}$  | 800            | Watts |
| Operating Temperature                                 | $T_J$     | -55°C to 150°C | °C    |
| Storage Temperature                                   | $T_{STG}$ | -55°C to 150°C | °C    |

| ELECTRICAL CHARACTERISTICS PER LINE @ 25°C Unless Otherwise Specified |  |   |  |   |   |   |   |
|---|--|---|--|---|---|---|---|
| PART NUMBER (Notes 1)   | RATED STAND-OFF VOLTAGE<br>$V_{WM}$<br>VOLTS | MINIMUM BREAKDOWN VOLTAGE<br>@ 1mA<br>$V_{(BR)}$<br>VOLTS | MAXIMUM CLAMPING VOLTAGE (See Fig. 2)<br>@ $I_p = 1 A$<br>$V_C$<br>VOLTS | MAXIMUM CLAMPING VOLTAGE (See Fig. 2)<br>@ 8/20 $\mu s$<br>$V_C @ I_{PP}$ | MAXIMUM LEAKAGE CURRENT<br>@ $V_{WM}$<br>$I_D$<br>$\mu A$ | MAXIMUM CAPACITANCE<br>@ 0V, 1 MHz<br>C<br>pF | TEMPERATURE COEFFICIENT OF $V_{(BR)}$<br>$\theta V_{(BR)}$<br>mV/°C |
| LCD05C  | 5.0  | 6.0   | 9.8  | 24V @ 45A   | 100   | 15  | 3   |
| LCD08C  | 8.0  | 8.5   | 12.3   | 25.5V @ 40A   | 10  | 15  | 9   |
| LCD12C  | 12.0   | 13.3  | 19.0   | 32V @ 34A   | 4   | 15  | 16  |
| LCD15C  | 15.0   | 16.7  | 25.5   | 38V @ 27A   | 4   | 15  | 17  |
| LCD24C  | 24.0   | 26.7  | 40.0   | 48V @ 22A   | 4   | 15  | 26  |

Note 1: Tested on pin pairs 1 & 16, 2 & 15, 3 & 14, 4 & 13, 5 & 12, 6 & 11, 7 & 10 and 8 & 9.



GRAPHS



## APPLICATION NOTE

The LCA Series are low capacitance, bidirectional TVS arrays that are designed to protect I/O or high speed data lines from the damaging effects of ESD or EFT. This product series has a surge capability of 800 Watts  $P_{pp}$  per line for an 8/20 $\mu$ s waveshape and offers ESD protection > 40kV.

### **BIDIRECTIONAL COMMON-MODE CONFIGURATION (Figure 1)**

Ideal for use in USB applications, the LCD Series provides up to eight (8) lines of protection in a common-mode configuration as depicted in Figure 1.

Circuit connectivity is as follows:

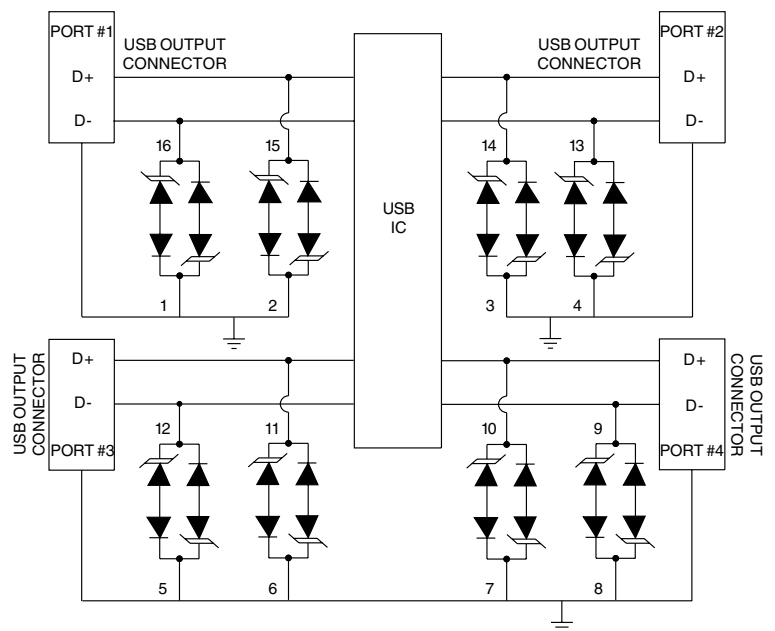
- ✓ Pins 2, 3, 4, 5, 6, and 7 are connected to ground.
- ✓ Pins 15 and 14 connected to Port #1 D- and D+.
- ✓ Pins 13 and 12 connected to Port #2 D+ and D-.
- ✓ Pins 11 and 10 connected to Port #3 D+ and D-.

### **CIRCUIT BOARD LAYOUT RECOMMENDATIONS**

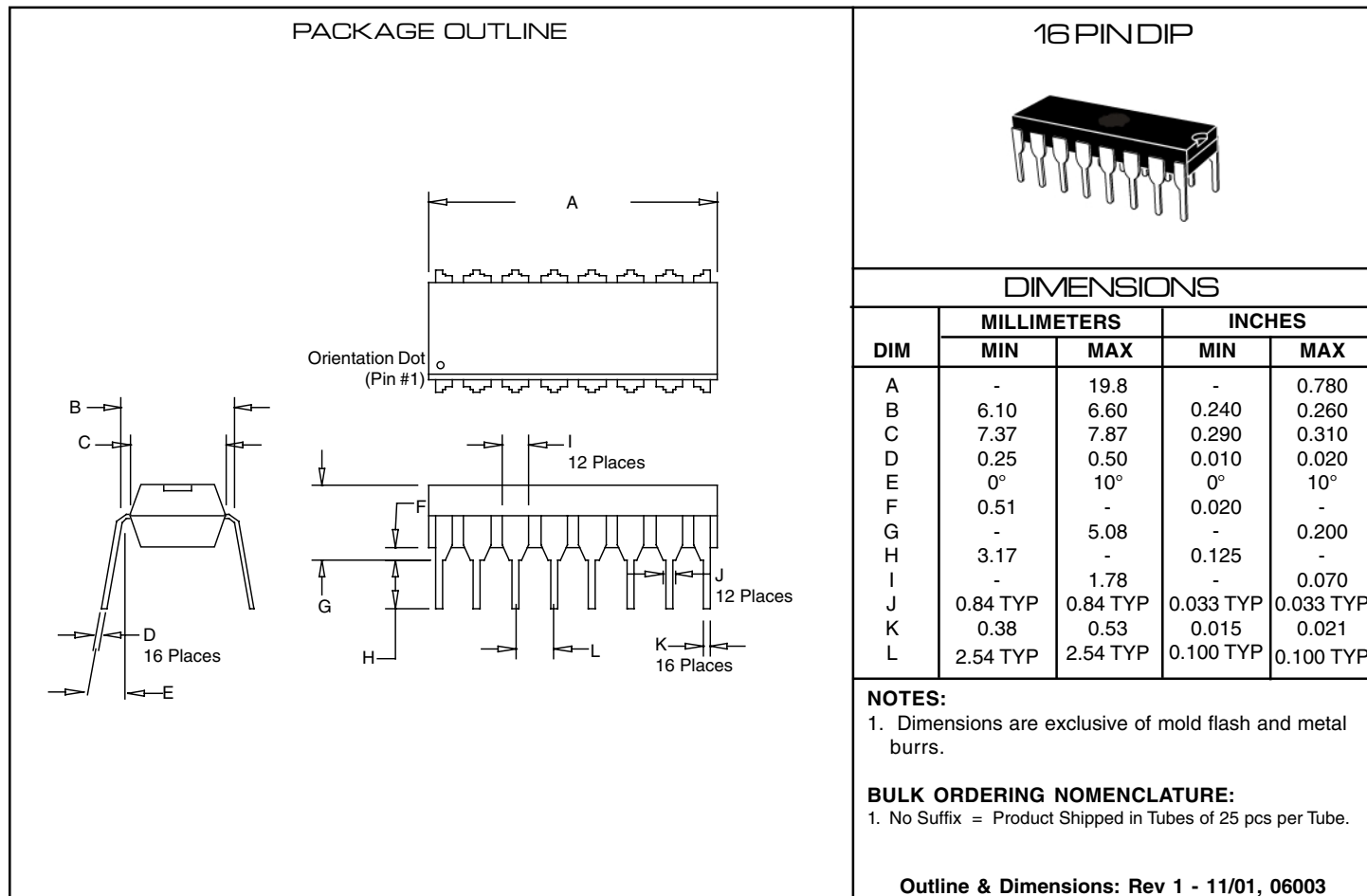
Circuit board layout is critical for Electromagnetic Compatibility (EMC) protection. The following guidelines are recommended:

- ✓ The protection device should be placed near the input terminals or connectors. By placing the TVS close to the connectors, the device will divert the transient current immediately before it can be coupled into the nearby traces.
- ✓ The path length between the TVS devices and the protected line should be minimized
- ✓ All conductive loops including power and ground loops should be minimized
- ✓ The transient current return path to ground should be kept as short as possible to reduce parasitic inductance.
- ✓ Ground planes should be used whenever possible. For Multilayer PCBs, use ground vias.

Figure1. Typical Common- Mode USB Protection Circuit



## PACKAGE OUTLINE & DIMENSIONS



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**ProTek Devices**

2929 South Fair Lane, Tempe, AZ 85282

Tel: 602-431-8101 Fax: 602-431-2288

E-Mail: [sales@protekdevices.com](mailto:sales@protekdevices.com)

Web Site: [www.protekdevices.com](http://www.protekdevices.com)